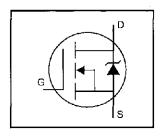
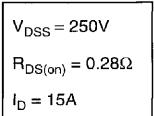
International Rectifier

IRFP244PbF

HEXFET® Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

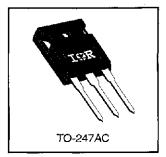




Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.



Absolute Maximum Ratings

| | Parameter | Max. | Units | |
|--|---------------------------------------|-----------------------|-------|--|
| I _D @ T _C = 25°C | Continuous Drain Current, VGS @ 10 V | 15 | | |
| I _D @ T _C = 100°C° | Continuous Drain Current, VGS @ 10 V | 9.7 | Α. | |
| Том | Pulsed Drain Current ① | 60 | | |
| P _D @ T _C = 25°C | Power Dissipation | 150 | w | |
| | Linear Derating Factor | 1.2 | W/°C | |
| V _{GS} | Gate-to-Source Voltage | ±20 | | |
| Eas | Single Pulse Avalanche Energy ② | 550 | mJ | |
| I _{AR} | Avalanche Current ① | 15 | A | |
| E _{AR} | Repetitive Avalanche Energy ① | 15 | mJ | |
| dv/dt | Peak Diode Recovery dv/dt ③ | 4.8 | V/ns | |
| TJ | Operating Junction and | -55 to +150 | | |
| Tstg | Storage Temperature Range | | °C | |
| | Soldering Temperature, for 10 seconds | 300 (1.6mm from case) | | |
| | Mounting Torque, 6-32 or M3 screw | 10 lbf•in (1.1 N•m) | | |

Thermal Resistance

| | Parameter | Min. | Тур. | Max. | Units |
|------|-------------------------------------|----------|------|------|-------|
| Reuc | Junction-to-Case | | _ | 0.83 | |
| Recs | Case-to-Sink, Flat, Greased Surface | | 0.24 | _ | °C/W |
| RoJA | Junction-to-Ambient | <u> </u> | _ | 40 |] |

6/1/04

Document Number: 91211

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

| | Parameter | Min. | Тур. | Max. | Units | Test Conditions | |
|--|--------------------------------------|----------|----------|----------|-------|---|--|
| V(BR)DSS | Drain-to-Source Breakdown Voltage | 250 | | | ٧ | V _{GS} =0V, I _D = 250μA | |
| ΔV _{(SR)DSS} /ΔT _J | Breakdown Voltage Temp. Coefficient | _ | 0.37 | <u> </u> | V/°C | Reference to 25°C, I _D = 1mA | |
| Ros(on) | Static Drain-to-Source On-Resistance | _ | ! — | 0.28 | Ω | V _{GS} =10V, I _D =9.0A ⊕ | |
| V _{GS(th)} | Gate Threshold Voltage | 2.0 | <u> </u> | 4.0 | V | V _{DS} =V _{GS} , I _D = 250μA | |
| g fs | Forward Transconductance | 6.7 | | _ | S | V _{DS} =50V, I _D =9.0A ④ | |
| 1 | Dunin to Course Lankson Current | | _ | 25 | А | V _{DS} =250V, V _{GS} =0V | |
| loss | Drain-to-Source Leakage Current | _ | _ | 250 | μA | V _{DS} =200V, V _{GS} =0V, T _J =125°0 | |
| Igss | Gate-to-Source Forward Leakage | _ | _ | 100 | nΑ | V _{GS} =20V | |
| 1688 | Gate-to-Source Reverse Leakage | _ | | -100 | 167 | V _{GS} =-20V | |
| Qg | Total Gate Charge | _ | _ | 63 | | ID=11A | |
| Qgs | Gate-to-Source Charge | | _ | 12 | nC | V _{DS} =200V | |
| \mathbf{Q}_{gd} | Gate-to-Drain ("Miller") Charge | | _ | 39 | | V _{GS} =10V See Fig. 6 and 13 ® | |
| t _{d(on)} | Turn-On Delay Time | _ | 14 | | | V _{DD} =125V | |
| \mathbf{t}_{r} | Rise Time | _ | 49 | | ns | I _D =11A | |
| t _{d(off)} | Turn-Off Delay Time | <u> </u> | 42 | | 1,13 | R _Θ =9.1Ω | |
| t f | Fall Time | - | 24 | _ | | R _D =11Ω See Figure 10 @ | |
| Lo | Internal Drain Inductance | _ | 5.0 | _ | nН | Between lead, 6 mm (0.25in.) from package | |
| Ls | Internal Source Inductance | _ | 13 | _ | | and center of die contact | |
| Ciss | Input Capacitance | _ | 1400 | _ | | V _{CS} =0V | |
| Coss | Output Capacitance | | 320 | _ | рF | V _{DS} = 25V | |
| Crss | Reverse Transfer Capacitance | - | 73 | | | f=1.0MHz See Figure 5 | |

Source-Drain Ratings and Characteristics

| | Parameter | Min. | Тур. | Max. | Units | Test Conditions |
|-----------------|---|----------|--|------|-------|--|
| Is | Continuous Source Current (Body Diode) | | _ | 15 | Α | MOSFET symbol showing the |
| Ism | Pulsed Source Current (Body Diode) ① | | _ | 60 | | integral reverse p-n junction diode. |
| V _{SD} | Diode Forward Voltage | - | _ | 1.8 | ٧ | T _J =25°C, I _S =15A, V _{GS} =0V ④ |
| trr | Reverse Recovery Time | | 290 | 570 | ns | T _J =25°C, I _F =11A |
| Qrr | Reverse Recovery Charge | | 3.1 | 6.3 | μC | di/dt=100A/μs ④ |
| ton | Forward Turn-On Time | Intrinsi | Intrinsic turn-on time is neglegible (turn-on is dominated by L _S +L _D) | | | |

Notes

- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)

- ④ Pulse width ≤ 300 μ s; duty cycle ≤2%.

Document Number: 91211

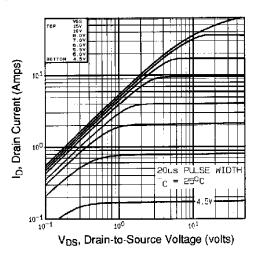


Fig 1. Typical Output Characteristics, Tc=25°C

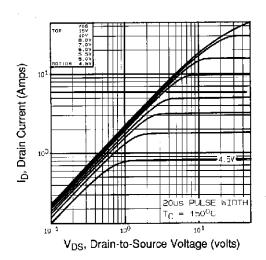


Fig 2. Typical Output Characteristics, Tc=150°C

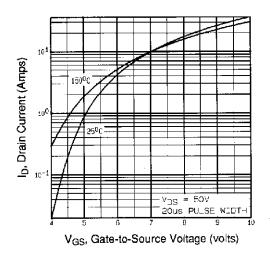


Fig 3. Typical Transfer Characteristics

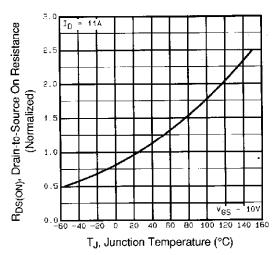


Fig 4. Normalized On-Resistance Vs. Temperature

Document Number: 91211

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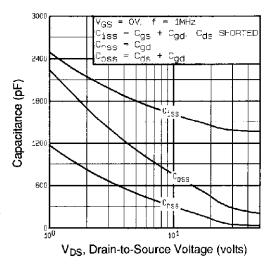


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

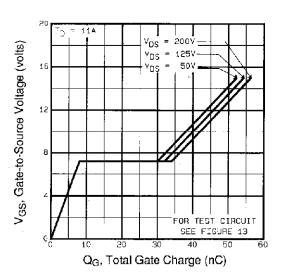


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

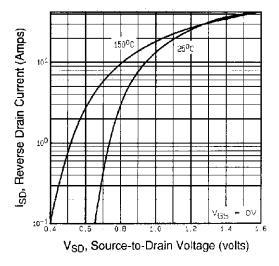


Fig 7. Typical Source-Drain Diode Forward Voltage

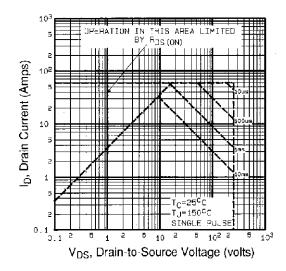


Fig 8. Maximum Safe Operating Area

Document Number: 91211

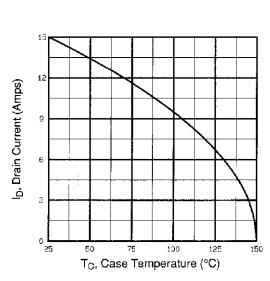


Fig 9. Maximum Drain Current Vs. Case Temperature

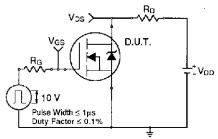


Fig 10a. Switching Time Test Circuit

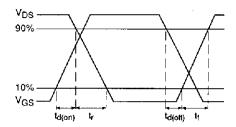


Fig 10b. Switching Time Waveforms

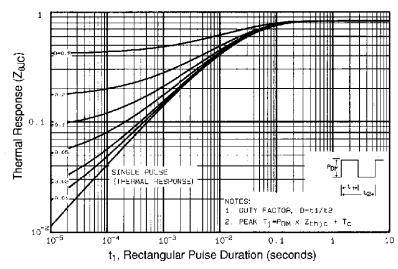


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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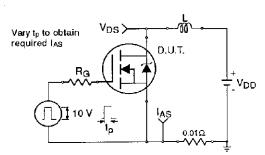


Fig 12a. Unclamped Inductive Test Circuit

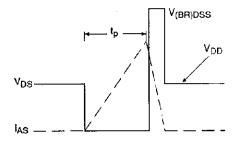


Fig 12b. Unclamped Inductive Waveforms

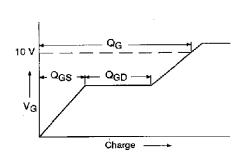


Fig 13a. Basic Gate Charge Waveform

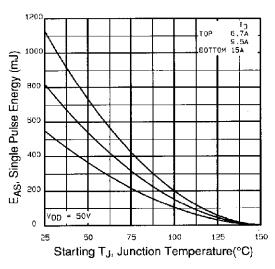


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

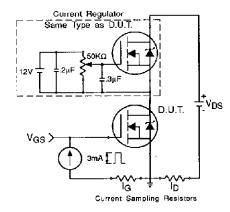


Fig 13b. Gate Charge Test Circuit

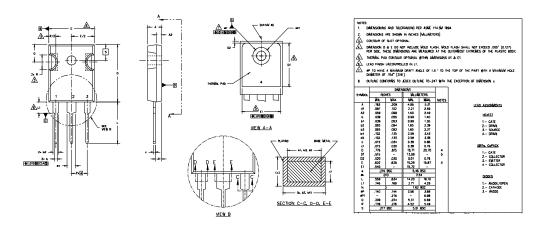
Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit - See page 1505



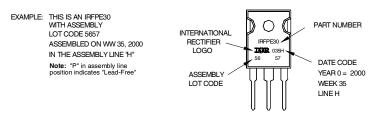
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TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



TO-247AC Part Marking Information



Data and specifications subject to change without notice.



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